

### FEATURES

High performance at low power

High speed

–3 dB bandwidth of 560 MHz,  $G = 1$

0.1 dB gain flatness to 300 MHz

Slew rate: 2800 V/ $\mu$ s, 25% to 75%

Fast 0.1% settling time of 9 ns

Low power: 9.6 mA per amplifier

Low harmonic distortion

100 dB SFDR @ 10 MHz

90 dB SFDR @ 20 MHz

Low input voltage noise: 3.6 nV/ $\sqrt{\text{Hz}}$

$\pm 0.5$  mV typical input offset voltage

Externally adjustable gain

Can be used with fractional differential gains

Differential-to-differential or single-ended-to-differential operation

Adjustable output common-mode voltage

Input common-mode range shifted down by  $1 V_{BE}$

Wide supply range: +3 V to  $\pm 5$  V

Available in 16-lead and 24-lead LFCSP packages

### APPLICATIONS

ADC drivers

Single-ended-to-differential converters

IF and baseband gain blocks

Differential buffers

Line drivers

### GENERAL DESCRIPTION

The ADA4932-x is the next generation AD8132 with higher performance, and lower noise and power consumption. It is an ideal choice for driving high performance ADCs as a single-ended-to-differential or differential-to-differential amplifier. The output common-mode voltage is user adjustable by means of an internal common-mode feedback loop, allowing the ADA4932-x output to match the input of the ADC. The internal feedback loop also provides exceptional output balance as well as suppression of even-order harmonic distortion products.

With the ADA4932-x, differential gain configurations are easily realized with a simple external four-resistor feedback network that determines the closed-loop gain of the amplifier.

The ADA4932-x is fabricated using the Analog Devices, Inc., proprietary silicon-germanium (SiGe) complementary bipolar process, enabling it to achieve low levels of distortion and noise at low power consumption. The low offset and excellent dynamic performance of the ADA4932-x make it well suited for a wide variety of data acquisition and signal processing applications.

Rev. B

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### FUNCTIONAL BLOCK DIAGRAMS

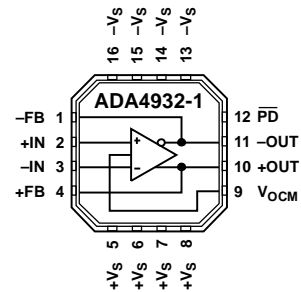


Figure 1. ADA4932-1

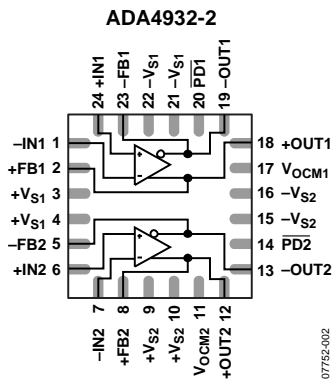


Figure 2. ADA4932-2

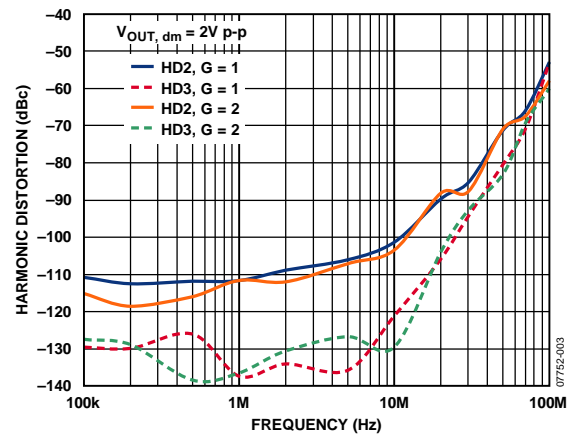


Figure 3. Harmonic Distortion vs. Frequency at Various Gains

The ADA4932-x is available in a Pb-free, 3 mm  $\times$  3 mm 16-lead LFCSP (ADA4932-1, single) or a Pb-free, 4 mm  $\times$  4 mm 24-lead LFCSP (ADA4932-2, dual). The pinout has been optimized to facilitate PCB layout and minimize distortion. The ADA4932-1 and the ADA4932-2 are specified to operate over the  $-40^{\circ}\text{C}$  to  $+105^{\circ}\text{C}$  temperature range; both operate on supplies between +3 V and  $\pm 5$  V.

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**REVISION HISTORY**

**3/13—Rev. A to Rev. B**

Updated Outline Dimensions ..... 26

Changes to Ordering Guide ..... 26

**8/09—Rev. 0 to Rev. A**

Changes to Features Section ..... 1

Changes to Figure 11 ..... 9

Changes to Figure 43 and Figure 45 ..... 15

Changes to Figure 52, Figure 53, and Figure 54 ..... 17

**10/08—Revision 0: Initial Version**

## SPECIFICATIONS

### ±5 V OPERATION

$T_A = 25^\circ\text{C}$ ,  $+V_S = 5\text{ V}$ ,  $-V_S = -5\text{ V}$ ,  $V_{\text{OCM}} = 0\text{ V}$ ,  $R_F = 499\ \Omega$ ,  $R_G = 499\ \Omega$ ,  $R_T = 53.6\ \Omega$  (when used),  $R_{L,\text{dm}} = 1\text{ k}\Omega$ , unless otherwise noted. All specifications refer to single-ended input and differential outputs, unless otherwise noted. Refer to Figure 55 for signal definitions.

### ± $D_{\text{IN}}$ to $V_{\text{OUT, dm}}$ Performance

Table 1.

Parameter	Conditions	Min	Typ	Max	Unit
<b>DYNAMIC PERFORMANCE</b>					
-3 dB Small Signal Bandwidth	$V_{\text{OUT, dm}} = 0.1\text{ V p-p}$		560		MHz
	$V_{\text{OUT, dm}} = 0.1\text{ V p-p}$ , $R_F = R_G = 205\ \Omega$		1000		MHz
-3 dB Large Signal Bandwidth	$V_{\text{OUT, dm}} = 2.0\text{ V p-p}$		360		MHz
	$V_{\text{OUT, dm}} = 2.0\text{ V p-p}$ , $R_F = R_G = 205\ \Omega$		360		MHz
Bandwidth for 0.1 dB Flatness	$V_{\text{OUT, dm}} = 2.0\text{ V p-p}$ , ADA4932-1, $R_L = 200\ \Omega$		300		MHz
	$V_{\text{OUT, dm}} = 2.0\text{ V p-p}$ , ADA4932-2, $R_L = 200\ \Omega$		100		MHz
Slew Rate	$V_{\text{OUT, dm}} = 2\text{ V p-p}$ , 25% to 75%		2800		V/ $\mu\text{s}$
Settling Time to 0.1%	$V_{\text{OUT, dm}} = 2\text{ V step}$		9		ns
Overdrive Recovery Time	$V_{\text{IN}} = 0\text{ V to }5\text{ V ramp}$ , $G = 2$		20		ns
<b>NOISE/HARMONIC PERFORMANCE</b>					
Second Harmonic	$V_{\text{OUT, dm}} = 2\text{ V p-p}$ , 1 MHz		-110		dBc
	$V_{\text{OUT, dm}} = 2\text{ V p-p}$ , 10 MHz		-100		dBc
	$V_{\text{OUT, dm}} = 2\text{ V p-p}$ , 20 MHz		-90		dBc
	$V_{\text{OUT, dm}} = 2\text{ V p-p}$ , 50 MHz		-72		dBc
Third Harmonic	$V_{\text{OUT, dm}} = 2\text{ V p-p}$ , 1 MHz		-130		dBc
	$V_{\text{OUT, dm}} = 2\text{ V p-p}$ , 10 MHz		-120		dBc
	$V_{\text{OUT, dm}} = 2\text{ V p-p}$ , 20 MHz		-105		dBc
	$V_{\text{OUT, dm}} = 2\text{ V p-p}$ , 50 MHz		-80		dBc
IMD	$f_1 = 30\text{ MHz}$ , $f_2 = 30.1\text{ MHz}$ , $V_{\text{OUT, dm}} = 2\text{ V p-p}$		-91		dBc
Voltage Noise (RTI)	$f = 1\text{ MHz}$		3.6		nV/ $\sqrt{\text{Hz}}$
Input Current Noise	$f = 1\text{ MHz}$		1.0		pA/ $\sqrt{\text{Hz}}$
Crosstalk	$f = 10\text{ MHz}$ , ADA4932-2		-100		dB
<b>INPUT CHARACTERISTICS</b>					
Offset Voltage	$V_{+\text{DIN}} = V_{-\text{DIN}} = V_{\text{OCM}} = 0\text{ V}$	-2.2	$\pm 0.5$	+2.2	mV
	$T_{\text{MIN}}$ to $T_{\text{MAX}}$ variation		-3.7		$\mu\text{V}/^\circ\text{C}$
Input Bias Current	$T_{\text{MIN}}$ to $T_{\text{MAX}}$ variation	-5.2	-2.5	-0.1	$\mu\text{A}$
			-9.5		nA/ $^\circ\text{C}$
Input Offset Current		-0.2	$\pm 0.025$	+0.2	$\mu\text{A}$
Input Resistance	Differential		11		M $\Omega$
	Common mode		16		M $\Omega$
Input Capacitance			0.5		pF
Input Common-Mode Voltage Range			$-V_S + 0.2$ to		V
			$+V_S - 1.8$		
CMRR	$\Delta V_{\text{OUT, dm}}/\Delta V_{\text{IN, cm}}$ , $\Delta V_{\text{IN, cm}} = \pm 1\text{ V}$		-100	-87	dB
Open-Loop Gain		64	66		dB
<b>OUTPUT CHARACTERISTICS</b>					
Output Voltage Swing	Maximum $\Delta V_{\text{OUT}}$ , single-ended output, $R_F = R_G = 10\text{ k}\Omega$ , $R_L = 1\text{ k}\Omega$	$-V_S + 1.4$ to $+V_S - 1.4$	$-V_S + 1.2$ to $+V_S - 1.2$		V
Linear Output Current	200 kHz, $R_{L,\text{dm}} = 10\ \Omega$ , SFDR = 68 dB		80		mA rms
Output Balance Error	$\Delta V_{\text{OUT, cm}}/\Delta V_{\text{OUT, dm}}$ , $\Delta V_{\text{OUT, dm}} = 2\text{ V p-p}$ , 1 MHz, see Figure 53 for output balance test circuit		-64	-60	dB

**$V_{OCM}$  to  $V_{OUT,cm}$  Performance**

Table 2.

Parameter	Conditions	Min	Typ	Max	Unit
$V_{OCM}$ DYNAMIC PERFORMANCE					
-3 dB Small Signal Bandwidth	$V_{OUT,cm} = 100$ mV p-p		270		MHz
-3 dB Large Signal Bandwidth	$V_{OUT,cm} = 2$ V p-p		105		MHz
Slew Rate	$V_{IN} = 1.5$ V to 3.5 V, 25% to 75%		410		V/ $\mu$ s
Input Voltage Noise (RTI)	$f = 1$ MHz		9.6		nV/ $\sqrt$ Hz
$V_{OCM}$ INPUT CHARACTERISTICS					
Input Voltage Range			$-V_S + 1.2$ to $+V_S - 1.2$		V
Input Resistance		22	25	29	k $\Omega$
Input Offset Voltage	$V_{+DIN} = V_{-DIN} = 0$ V	-5.1	$\pm 1$	+5.1	mV
$V_{OCM}$ CMRR	$\Delta V_{OUT,dm}/\Delta V_{OCM}, \Delta V_{OCM} = \pm 1$ V		-100	-86	dB
Gain	$\Delta V_{OUT,cm}/\Delta V_{OCM}, \Delta V_{OCM} = \pm 1$ V	0.995	0.998	1.000	V/V

**General Performance**

Table 3.

Parameter	Conditions	Min	Typ	Max	Unit
POWER SUPPLY					
Operating Range		3.0		11	V
Quiescent Current per Amplifier		9.0	9.6	10.1	mA
	$T_{MIN}$ to $T_{MAX}$ variation		35		$\mu$ A/ $^{\circ}$ C
	Powered down		0.9	1.0	mA
Power Supply Rejection Ratio	$\Delta V_{OUT,dm}/\Delta V_S, \Delta V_S = 1$ V p-p		-96	-84	dB
POWER-DOWN (PD)					
$\overline{PD}$ Input Voltage	Powered down		$\leq (+V_S - 2.5)$		V
	Enabled		$\geq (+V_S - 1.8)$		V
Turn-Off Time			1100		ns
Turn-On Time			16		ns
$\overline{PD}$ Pin Bias Current per Amplifier					$\mu$ A
Enabled	$\overline{PD} = 5$ V	-10	+0.7	+10	$\mu$ A
Disabled	$\overline{PD} = 0$ V	-240	-195	-140	$\mu$ A
OPERATING TEMPERATURE RANGE					
		-40		+105	$^{\circ}$ C

**5 V OPERATION**

$T_A = 25^\circ\text{C}$ ,  $+V_S = 5\text{ V}$ ,  $-V_S = 0\text{ V}$ ,  $V_{OCM} = 2.5\text{ V}$ ,  $R_F = 499\ \Omega$ ,  $R_G = 499\ \Omega$ ,  $R_T = 53.6\ \Omega$  (when used),  $R_{L, dm} = 1\text{ k}\Omega$ , unless otherwise noted. All specifications refer to single-ended input and differential outputs, unless otherwise noted. Refer to Figure 55 for signal definitions.

 **$\pm D_{IN}$  to  $V_{OUT, dm}$  Performance**

Table 4.

Parameter	Conditions	Min	Typ	Max	Unit
<b>DYNAMIC PERFORMANCE</b>					
-3 dB Small Signal Bandwidth	$V_{OUT, dm} = 0.1\text{ V p-p}$		560		MHz
	$V_{OUT, dm} = 0.1\text{ V p-p}$ , $R_F = R_G = 205\ \Omega$		990		MHz
-3 dB Large Signal Bandwidth	$V_{OUT, dm} = 2.0\text{ V p-p}$		315		MHz
	$V_{OUT, dm} = 2.0\text{ V p-p}$ , $R_F = R_G = 205\ \Omega$		320		MHz
Bandwidth for 0.1 dB Flatness	$V_{OUT, dm} = 2.0\text{ V p-p}$ , ADA4932-1, $R_L = 200\ \Omega$		120		MHz
	$V_{OUT, dm} = 2.0\text{ V p-p}$ , ADA4932-2, $R_L = 200\ \Omega$		200		MHz
Slew Rate	$V_{OUT, dm} = 2\text{ V p-p}$ , 25% to 75%		2200		V/ $\mu\text{s}$
Settling Time to 0.1%	$V_{OUT, dm} = 2\text{ V step}$		10		ns
Overdrive Recovery Time	$V_{IN} = 0\text{ V to } 2.5\text{ V ramp}$ , $G = 2$		20		ns
<b>NOISE/HARMONIC PERFORMANCE</b>					
Second Harmonic	$V_{OUT, dm} = 2\text{ V p-p}$ , 1 MHz		-110		dBc
	$V_{OUT, dm} = 2\text{ V p-p}$ , 10 MHz		-100		dBc
	$V_{OUT, dm} = 2\text{ V p-p}$ , 20 MHz		-90		dBc
	$V_{OUT, dm} = 2\text{ V p-p}$ , 50 MHz		-72		dBc
Third Harmonic	$V_{OUT, dm} = 2\text{ V p-p}$ , 1 MHz		-120		dBc
	$V_{OUT, dm} = 2\text{ V p-p}$ , 10 MHz		-100		dBc
	$V_{OUT, dm} = 2\text{ V p-p}$ , 20 MHz		-87		dBc
	$V_{OUT, dm} = 2\text{ V p-p}$ , 50 MHz		-70		dBc
IMD	$f_1 = 30\text{ MHz}$ , $f_2 = 30.1\text{ MHz}$ , $V_{OUT, dm} = 2\text{ V p-p}$		-91		dBc
Voltage Noise (RTI)	$f = 1\text{ MHz}$		3.6		nV/ $\sqrt{\text{Hz}}$
Input Current Noise	$f = 1\text{ MHz}$		1.0		pA/ $\sqrt{\text{Hz}}$
Crosstalk	$f = 10\text{ MHz}$ , ADA4932-2		-100		dB
<b>INPUT CHARACTERISTICS</b>					
Offset Voltage	$V_{+DIN} = V_{-DIN} = V_{OCM} = 2.5\text{ V}$	-2.2	$\pm 0.5$	+2.2	mV
	$T_{MIN}$ to $T_{MAX}$ variation		-3.7		$\mu\text{V}/^\circ\text{C}$
Input Bias Current		-5.3	-3.0	-0.23	$\mu\text{A}$
	$T_{MIN}$ to $T_{MAX}$ variation		-9.5		nA/ $^\circ\text{C}$
Input Offset Current		-0.25	$\pm 0.025$	+0.25	$\mu\text{A}$
Input Resistance	Differential		11		M $\Omega$
	Common mode		16		M $\Omega$
Input Capacitance			0.5		pF
Input Common-Mode Voltage Range			$-V_S + 0.2$ to		V
			$+V_S - 1.8$		
CMRR	$\Delta V_{OUT, dm}/\Delta V_{IN, cm}$ , $\Delta V_{IN, cm} = \pm 1\text{ V}$		-100	-87	dB
Open-Loop Gain		64	66		dB
<b>OUTPUT CHARACTERISTICS</b>					
Output Voltage Swing	Maximum $\Delta V_{OUT}$ , single-ended output, $R_F = R_G = 10\text{ k}\Omega$ , $R_L = 1\text{ k}\Omega$	$-V_S + 1.15$ to $+V_S - 1.15$	$-V_S + 1.02$ to $+V_S - 1.02$		V
Linear Output Current	200 kHz, $R_{L, dm} = 10\ \Omega$ , SFDR = 67 dB		53		mA rms
Output Balance Error	$\Delta V_{OUT, cm}/\Delta V_{OUT, dm}$ , $\Delta V_{OUT, dm} = 1\text{ V p-p}$ , 1 MHz, see Figure 53 for output balance test circuit		-64	-60	dB

**$V_{OCM}$  to  $V_{OUT,cm}$  Performance**

Table 5.

Parameter	Conditions	Min	Typ	Max	Unit
$V_{OCM}$ DYNAMIC PERFORMANCE					
-3 dB Small Signal Bandwidth	$V_{OUT,cm} = 100$ mV p-p		260		MHz
-3 dB Large Signal Bandwidth	$V_{OUT,cm} = 2$ V p-p		90		MHz
Slew Rate	$V_{IN} = 1.5$ V to 3.5 V, 25% to 75%		360		V/ $\mu$ s
Input Voltage Noise (RTI)	$f = 1$ MHz		9.6		nV/ $\sqrt{\text{Hz}}$
$V_{OCM}$ INPUT CHARACTERISTICS					
Input Voltage Range			$-V_S + 1.2$ to $+V_S - 1.2$		V
Input Resistance		22	25	29	k $\Omega$
Input Offset Voltage	$V_{+DIN} = V_{-DIN} = 2.5$ V	-6.5	-3.0	+6.5	mV
$V_{OCM}$ CMRR	$\Delta V_{OUT,dm}/\Delta V_{OCM}, \Delta V_{OCM} = \pm 1$ V		-100	-86	dB
Gain	$\Delta V_{OUT,cm}/\Delta V_{OCM}, \Delta V_{OCM} = \pm 1$ V	0.995	0.998	1.000	V/V

**General Performance**

Table 6.

Parameter	Conditions	Min	Typ	Max	Unit
POWER SUPPLY					
Operating Range		3.0		11	V
Quiescent Current per Amplifier		8.2	8.8	9.5	mA
	$T_{MIN}$ to $T_{MAX}$ variation		35		$\mu$ A/ $^{\circ}$ C
	Powered down		0.7	0.8	mA
Power Supply Rejection Ratio	$\Delta V_{OUT,dm}/\Delta V_S, \Delta V_S = 1$ V p-p		-96	-84	dB
POWER-DOWN ( $\overline{PD}$ )					
$\overline{PD}$ Input Voltage	Powered down		$\leq (+V_S - 2.5)$		V
	Enabled		$\geq (+V_S - 1.8)$		V
Turn-Off Time			1100		ns
Turn-On Time			16		ns
$\overline{PD}$ Pin Bias Current per Amplifier					$\mu$ A
Enabled	$\overline{PD} = 5$ V	-10	+0.7	+10	$\mu$ A
Disabled	$\overline{PD} = 0$ V	-100	-70	-40	$\mu$ A
OPERATING TEMPERATURE RANGE					
		-40		+105	$^{\circ}$ C

## ABSOLUTE MAXIMUM RATINGS

Table 7.

Parameter	Rating
Supply Voltage	11 V
Power Dissipation	See Figure 4
Input Current, +IN, -IN, $\overline{PD}$	$\pm 5$ mA
Storage Temperature Range	-65°C to +125°C
Operating Temperature Range	
ADA4932-1	-40°C to +105°C
ADA4932-2	-40°C to +105°C
Lead Temperature (Soldering, 10 sec)	300°C
Junction Temperature	150°C

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### THERMAL RESISTANCE

$\theta_{JA}$  is specified for the device (including exposed pad) soldered to a high thermal conductivity 2s2p circuit board, as described in EIA/JESD 51-7.

Table 8. Thermal Resistance

Package Type	$\theta_{JA}$	Unit
ADA4932-1, 16-Lead LFCSP (Exposed Pad)	91	°C/W
ADA4932-2, 24-Lead LFCSP (Exposed Pad)	65	°C/W

### MAXIMUM POWER DISSIPATION

The maximum safe power dissipation in the ADA4932-x package is limited by the associated rise in junction temperature ( $T_J$ ) on the die. At approximately 150°C, which is the glass transition temperature, the plastic changes its properties. Even temporarily exceeding this temperature limit can change the stresses that the package exerts on the die, permanently shifting the parametric performance of the ADA4932-x. Exceeding a junction temperature of 150°C for an extended period can result in changes in the silicon devices, potentially causing failure.

The power dissipated in the package ( $P_D$ ) is the sum of the quiescent power dissipation and the power dissipated in the package due to the load drive. The quiescent power is the voltage between the supply pins ( $V_S$ ) times the quiescent current ( $I_S$ ). The power dissipated due to the load drive depends upon the particular application. The power due to load drive is calculated by multiplying the load current by the associated voltage drop across the device. RMS voltages and currents must be used in these calculations.

Airflow increases heat dissipation, effectively reducing  $\theta_{JA}$ . In addition, more metal directly in contact with the package leads/exposed pad from metal traces, through holes, ground, and power planes reduces  $\theta_{JA}$ .

Figure 4 shows the maximum safe power dissipation in the package vs. the ambient temperature for the single 16-lead LFCSP (91°C/W) and the dual 24-lead LFCSP (65°C/W) on a JEDEC standard 4-layer board with the exposed pad soldered to a PCB pad that is connected to a solid plane.

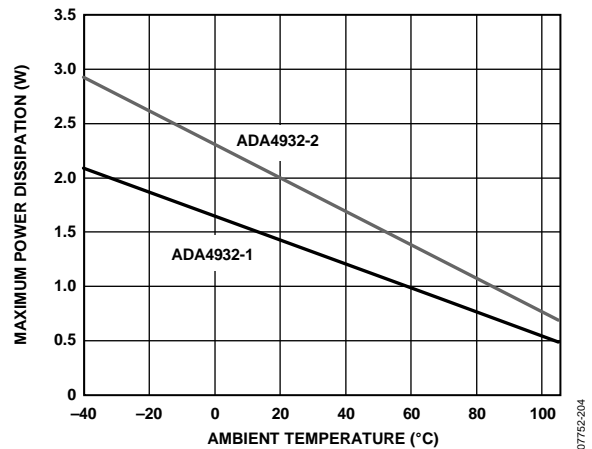


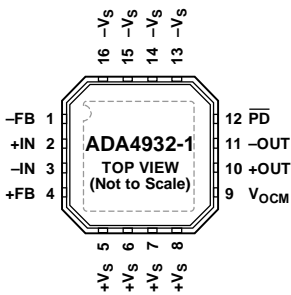
Figure 4. Maximum Power Dissipation vs. Ambient Temperature for a 4-Layer Board

### ESD CAUTION



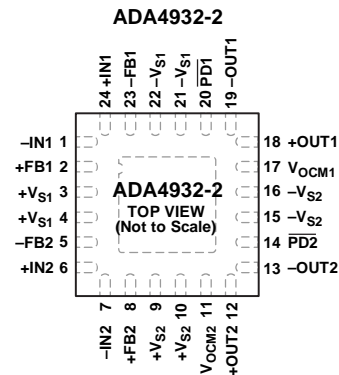
**ESD (electrostatic discharge) sensitive device.** Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

## PIN CONFIGURATIONS AND FUNCTION DESCRIPTIONS



NOTES  
1. SOLDER EXPOSED PADDLE ON BACK OF PACKAGE TO GROUND PLANE OR TO A POWER PLANE.

Figure 5. ADA4932-1 Pin Configuration



NOTES  
1. SOLDER EXPOSED PADDLE ON BACK OF PACKAGE TO GROUND PLANE OR TO A POWER PLANE.

Figure 6. ADA4932-2 Pin Configuration

Table 9. ADA4932-1 Pin Function Descriptions

Pin No.	Mnemonic	Description
1	-FB	Negative Output for Feedback Component Connection.
2	+IN	Positive Input Summing Node.
3	-IN	Negative Input Summing Node.
4	+FB	Positive Output for Feedback Component Connection.
5 to 8	+Vs	Positive Supply Voltage.
9	V <sub>OCM</sub>	Output Common-Mode Voltage.
10	+OUT	Positive Output for Load Connection.
11	-OUT	Negative Output for Load Connection.
12	PD	Power-Down Pin.
13 to 16	-Vs	Negative Supply Voltage.
17 (EPAD)	Exposed Paddle (EPAD)	Solder the exposed paddle on the back of the package to a ground plane or a power plane.

Table 10. ADA4932-2 Pin Function Descriptions

Pin No.	Mnemonic	Description
1	-IN1	Negative Input Summing Node 1.
2	+FB1	Positive Output Feedback 1.
3, 4	+Vs1	Positive Supply Voltage 1.
5	-FB2	Negative Output Feedback 2.
6	+IN2	Positive Input Summing Node 2.
7	-IN2	Negative Input Summing Node 2.
8	+FB2	Positive Output Feedback 2.
9, 10	+Vs2	Positive Supply Voltage 2.
11	V <sub>OCM2</sub>	Output Common-Mode Voltage 2.
12	+OUT2	Positive Output 2.
13	-OUT2	Negative Output 2.
14	PD2	Power-Down Pin 2.
15, 16	-Vs2	Negative Supply Voltage 2.
17	V <sub>OCM1</sub>	Output Common-Mode Voltage 1.
18	+OUT1	Positive Output 1.
19	-OUT1	Negative Output 1.
20	PD1	Power-Down Pin 1.
21, 22	-Vs1	Negative Supply Voltage 1.
23	-FB1	Negative Output Feedback 1.
24	+IN1	Positive Input Summing Node 1.
25 (EPAD)	Exposed Paddle (EPAD)	Solder the exposed paddle on the back of the package to a ground plane or a power plane.



### TYPICAL PERFORMANCE CHARACTERISTICS

$T_A = 25^\circ\text{C}$ ,  $+V_S = 5\text{ V}$ ,  $-V_S = -5\text{ V}$ ,  $V_{\text{OCM}} = 0\text{ V}$ ,  $R_G = 499\ \Omega$ ,  $R_F = 499\ \Omega$ ,  $R_T = 53.6\ \Omega$  (when used),  $R_{L, \text{dm}} = 1\text{ k}\Omega$ , unless otherwise noted. Refer to Figure 52 for test setup. Refer to Figure 55 for signal definitions.



Figure 7. Small Signal Frequency Response for Various Gains



Figure 10. Large Signal Frequency Response for Various Gains

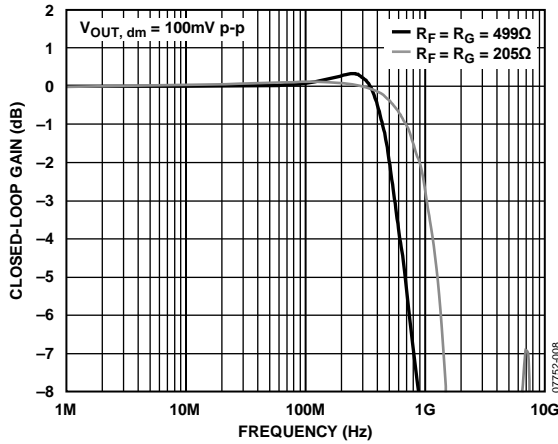


Figure 8. Small Signal Frequency Response for Various  $R_F$  and  $R_G$

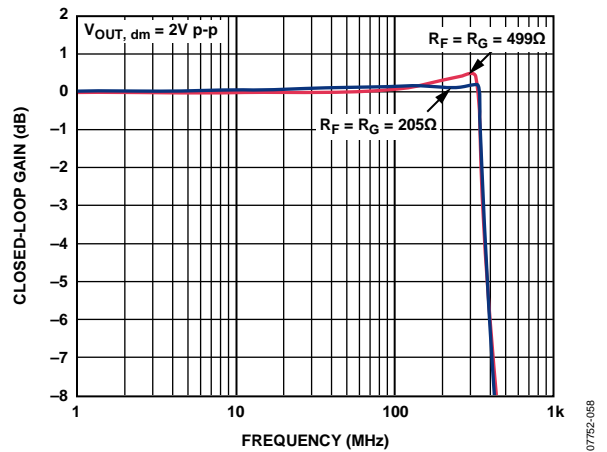


Figure 11. Large Signal Frequency Response for Various  $R_F$  and  $R_G$



Figure 9. Small Signal Frequency Response for Various Supplies

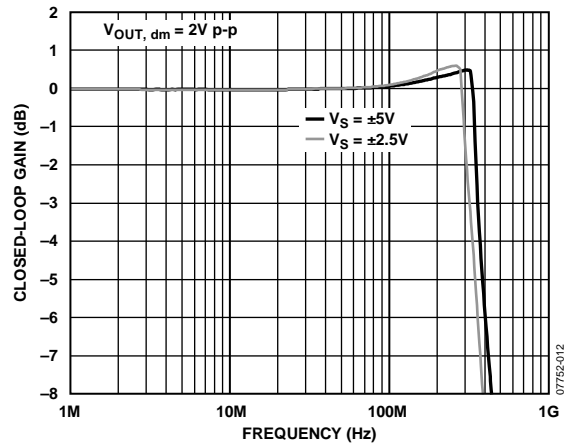


Figure 12. Large Signal Frequency Response for Various Supplies

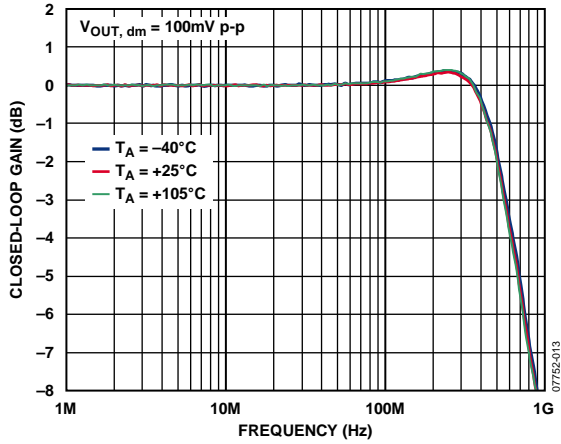


Figure 13. Small Signal Frequency Response for Various Temperatures

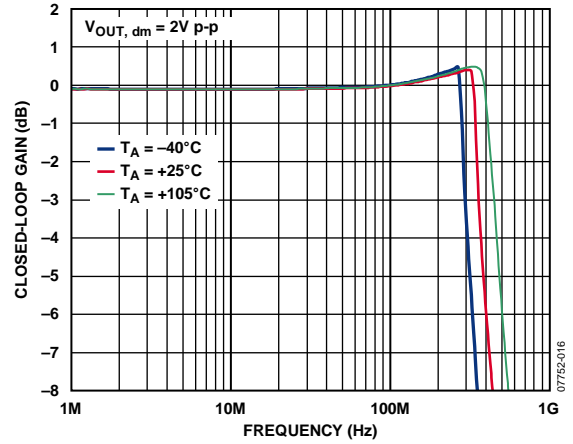


Figure 16. Large Signal Frequency Response for Various Temperatures

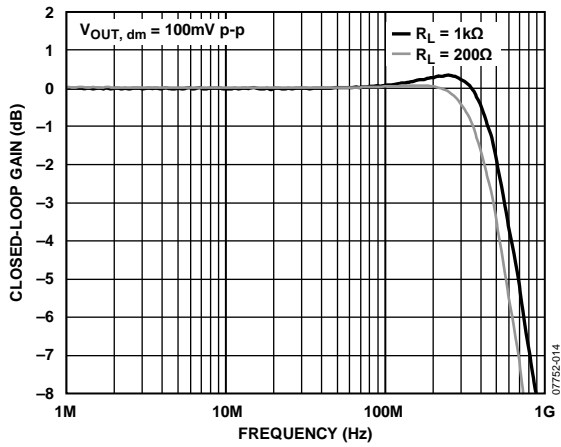


Figure 14. Small Signal Frequency Response at Various Loads

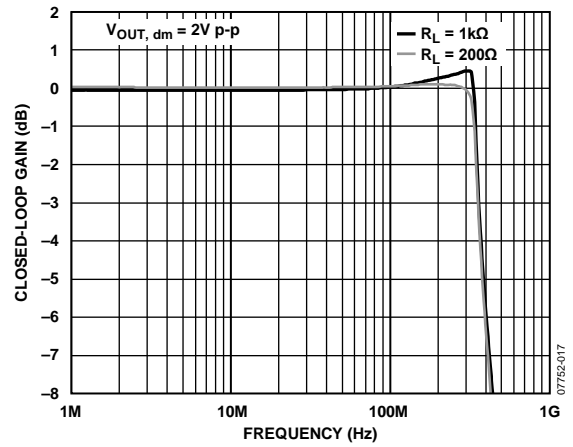


Figure 17. Large Signal Frequency Response at Various Loads

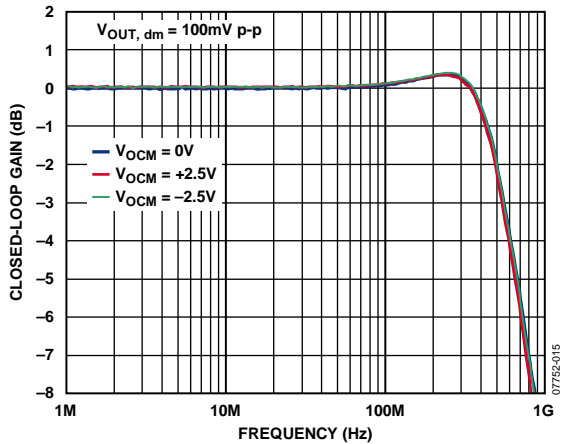


Figure 15. Small Signal Frequency Response for Various  $V_{OCM}$  Levels

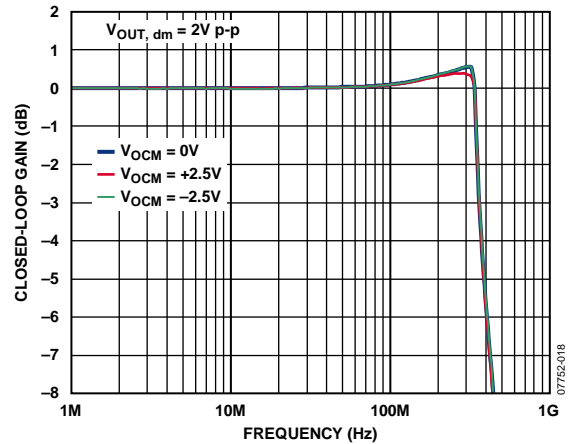


Figure 18. Large Signal Frequency Response for Various  $V_{OCM}$  Levels



Figure 19. Small Signal Frequency Response at Various Capacitive Loads



Figure 22. Large Signal Frequency Response at Various Capacitive Loads

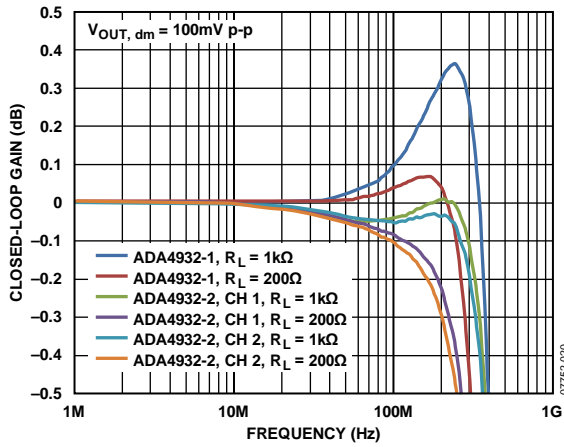


Figure 20. 0.1 dB Flatness Small Signal Frequency Response for Various Loads



Figure 23. 0.1 dB Flatness Large Signal Frequency Response for Various Loads



Figure 21.  $V_{OCM}$  Small Signal Frequency Response at Various DC Levels



Figure 24.  $V_{OCM}$  Large Signal Frequency Response at Various DC Levels



Figure 25. Harmonic Distortion vs. Frequency at Various Loads



Figure 28. Harmonic Distortion vs. Frequency at Various Gains



Figure 26. Harmonic Distortion vs. Frequency at Various Supplies



Figure 29. Harmonic Distortion vs.  $V_{OUT, dm}$  and Supply Voltage,  $f = 10\text{ MHz}$



Figure 27. Harmonic Distortion vs.  $V_{OCM}$  at Various Frequencies,  $\pm 5\text{ V}$  Supplies



Figure 30. Harmonic Distortion vs.  $V_{OCM}$  at Various Frequencies,  $+5\text{ V}$  Supply



Figure 31. Harmonic Distortion vs. Frequency at Various  $V_{OUT,dm}$

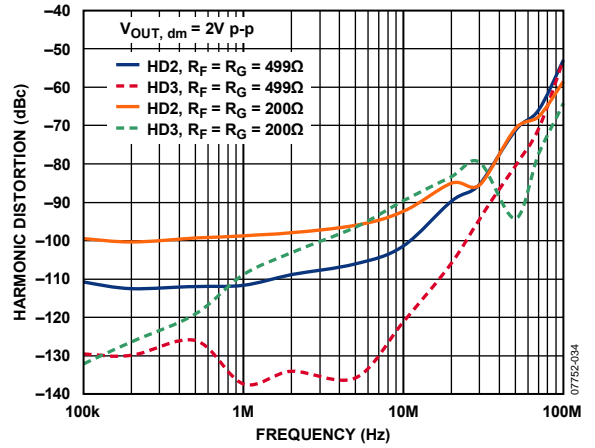


Figure 34. Harmonic Distortion vs. Frequency at Various  $R_F$  and  $R_G$



Figure 32. Spurious-Free Dynamic Range vs. Frequency at Various Loads

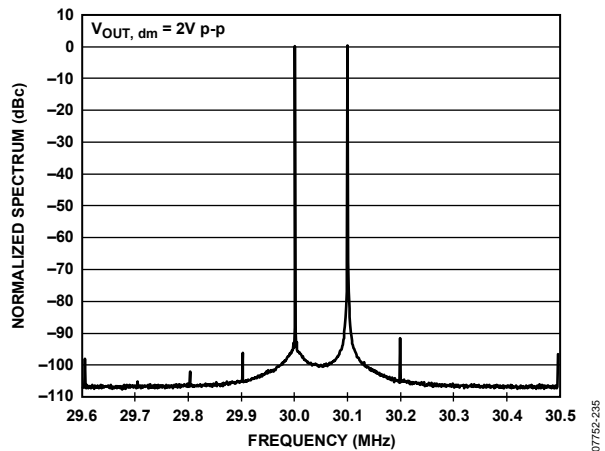


Figure 35. 30 MHz Intermodulation Distortion



Figure 33. CMRR vs. Frequency

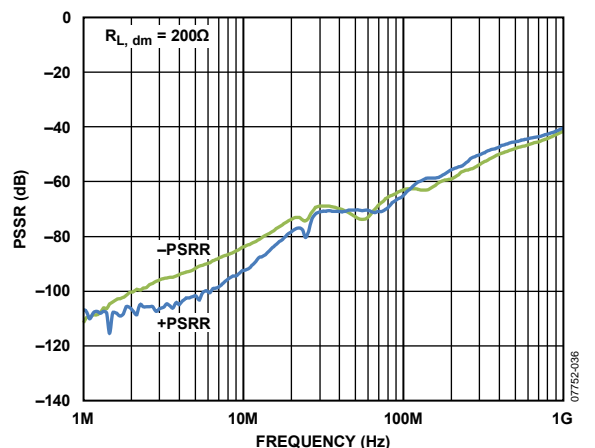


Figure 36. PSRR vs. Frequency

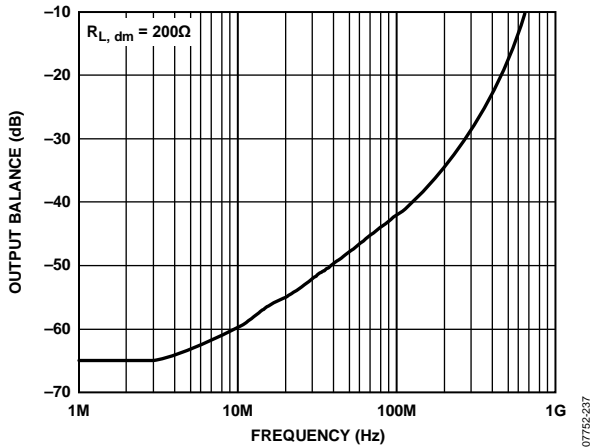


Figure 37. Output Balance vs. Frequency

07752-237

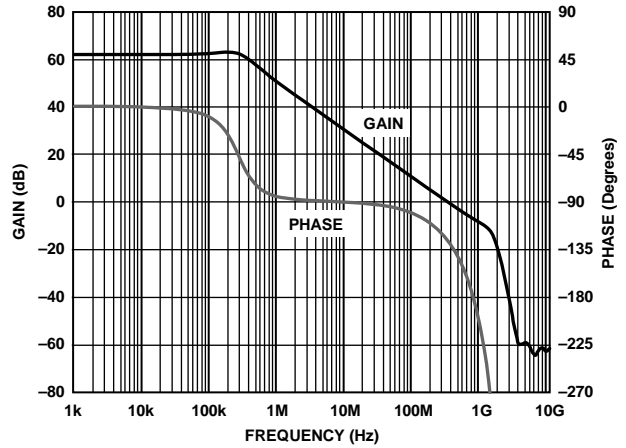


Figure 40. Open-Loop Gain and Phase vs. Frequency

07752-240

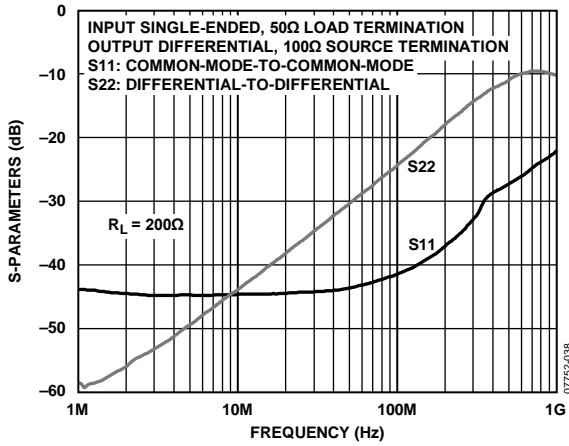


Figure 38. Return Loss ( $S_{11}$ ,  $S_{22}$ ) vs. Frequency

07752-038



Figure 41. Closed-Loop Output Impedance Magnitude vs. Frequency,  $G = 1$

07752-241

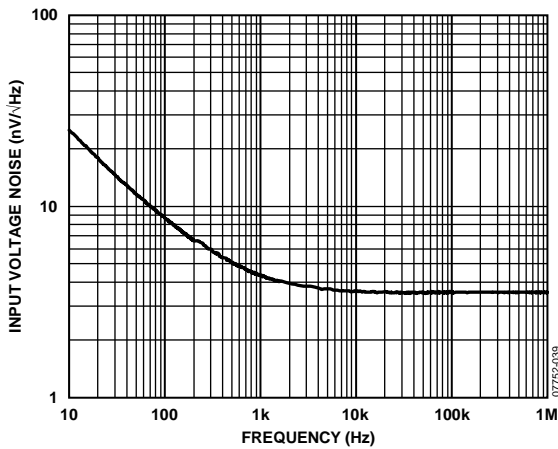


Figure 39. Voltage Noise Spectral Density, Referred to Input

07752-039

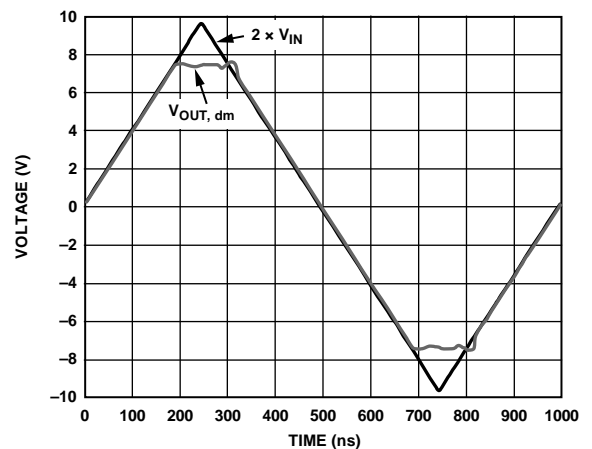


Figure 42. Overdrive Recovery,  $G = 2$

07752-242



Figure 43. Small Signal Pulse Response



Figure 46. Large Signal Pulse Response



Figure 44. Small Signal Pulse Response for Various Capacitive Loads



Figure 47. Large Signal Pulse Response for Various Capacitive Loads



Figure 45.  $V_{OCM}$  Small Signal Pulse Response



Figure 48.  $V_{OCM}$  Large Signal Pulse Response

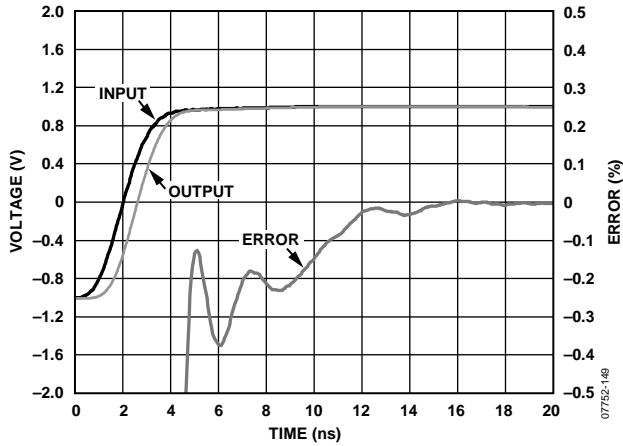


Figure 49. Settling Time



Figure 51. PD Response Time

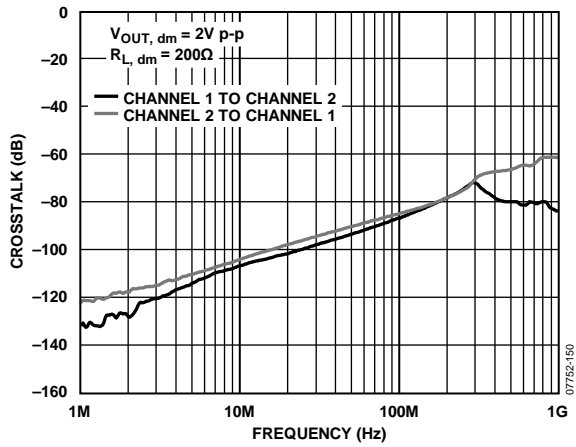


Figure 50. Crosstalk vs. Frequency, ADA4932-2



TEST CIRCUITS



Figure 52. Equivalent Basic Test Circuit,  $G = 1$

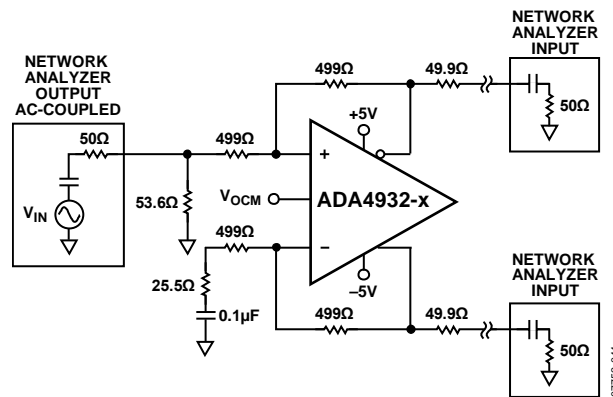


Figure 53. Test Circuit for Output Balance, CMRR

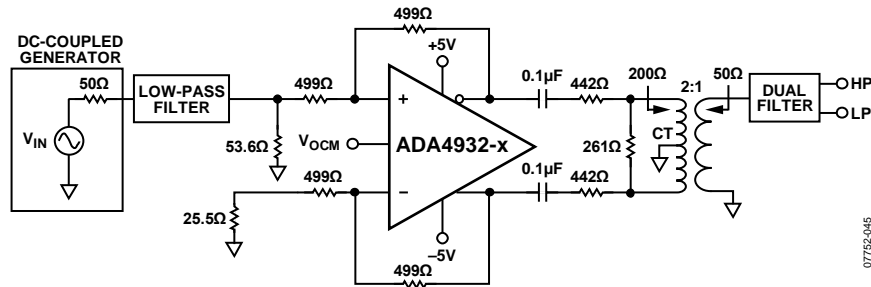


Figure 54. Test Circuit for Distortion Measurements

**TERMINOLOGY**

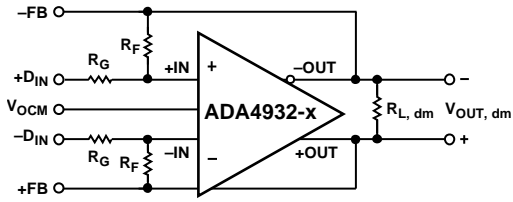


Figure 55. Signal and Circuit Definitions

07752-546

**Differential Voltage**

Differential voltage refers to the difference between two node voltages. For example, the output differential voltage (or equivalently, output differential mode voltage) is defined as

$$V_{OUT, dm} = (V_{+OUT} - V_{-OUT})$$

where  $V_{+OUT}$  and  $V_{-OUT}$  refer to the voltages at the +OUT and -OUT terminals with respect to a common ground reference. Similarly, the differential input voltage is defined as

$$V_{IN, dm} = (+D_{IN} - (-D_{IN}))$$

**Common-Mode Voltage**

Common-mode voltage refers to the average of two node voltages with respect to the local ground reference. The output common-mode voltage is defined as

$$V_{OUT, cm} = (V_{+OUT} + V_{-OUT})/2$$

**Balance**

Output balance is a measure of how close the output differential signals are to being equal in amplitude and opposite in phase. Output balance is most easily determined by placing a well-matched resistor divider between the differential voltage nodes and comparing the magnitude of the signal at the divider midpoint with the magnitude of the differential signal (see Figure 53). By this definition, output balance is the magnitude of the output common-mode voltage divided by the magnitude of the output differential mode voltage.

$$Output\ Balance\ Error = \left| \frac{\Delta V_{OUT, cm}}{\Delta V_{OUT, dm}} \right|$$

## THEORY OF OPERATION

The ADA4932-x differs from conventional op amps in that it has two outputs whose voltages move in opposite directions and an additional input,  $V_{OCM}$ . Like an op amp, it relies on high open-loop gain and negative feedback to force these outputs to the desired voltages. The ADA4932-x behaves much like a standard voltage feedback op amp and facilitates single-ended-to-differential conversions, common-mode level shifting, and amplifications of differential signals. Like an op amp, the ADA4932-x has high input impedance and low output impedance. Because it uses voltage feedback, the ADA4932-x manifests a nominally constant gain bandwidth product.

Two feedback loops are employed to control the differential and common-mode output voltages. The differential feedback, set

with external resistors, controls only the differential output voltage. The common-mode feedback controls only the common-mode output voltage. This architecture makes it easy to set the output common-mode level to any arbitrary value within the specified limits. The output common-mode voltage is forced, by the internal common-mode feedback loop, to be equal to the voltage applied to the  $V_{OCM}$  input.

The internal common-mode feedback loop produces outputs that are highly balanced over a wide frequency range without requiring tightly matched external components. This results in differential outputs that are very close to the ideal of being identical in amplitude and are exactly  $180^\circ$  apart in phase.

## APPLICATIONS INFORMATION

### ANALYZING AN APPLICATION CIRCUIT

The ADA4932-x uses high open-loop gain and negative feedback to force its differential and common-mode output voltages in such a way as to minimize the differential and common-mode error voltages. The differential error voltage is defined as the voltage between the differential inputs labeled +IN and -IN (see Figure 55). For most purposes, this voltage can be assumed to be zero. Similarly, the difference between the actual output common-mode voltage and the voltage applied to V<sub>OCM</sub> can also be assumed to be zero. Starting from these principles, any application circuit can be analyzed.

### SETTING THE CLOSED-LOOP GAIN

Using the approach described in the Analyzing an Application Circuit section, the differential gain of the circuit in Figure 55 can be determined by

$$\left| \frac{V_{OUT, dm}}{V_{IN, dm}} \right| = \frac{R_F}{R_G}$$

This presumes that the input resistors (R<sub>G</sub>) and feedback resistors (R<sub>F</sub>) on each side are equal.

### ESTIMATING THE OUTPUT NOISE VOLTAGE

The differential output noise of the ADA4932-x can be estimated using the noise model in Figure 56. The input-referred noise voltage density, v<sub>nIN</sub>, is modeled as a differential

input, and the noise currents, i<sub>nIN-</sub> and i<sub>nIN+</sub>, appear between each input and ground. The output voltage due to v<sub>nIN</sub> is obtained by multiplying v<sub>nIN</sub> by the noise gain, G<sub>N</sub> (defined in the G<sub>N</sub> equation that follows). The noise currents are uncorrelated with the same mean-square value, and each produces an output voltage that is equal to the noise current multiplied by the associated feedback resistance. The noise voltage density at the V<sub>OCM</sub> pin is v<sub>nCM</sub>. When the feedback networks have the same feedback factor, as is true in most cases, the output noise due to v<sub>nCM</sub> is common mode. Each of the four resistors contributes (4kTR<sub>xx</sub>)<sup>1/2</sup>. The noise from the feedback resistors appears directly at the output, and the noise from the gain resistors appears at the output multiplied by R<sub>F</sub>/R<sub>G</sub>. Table 11 summarizes the input noise sources, the multiplication factors, and the output-referred noise density terms.

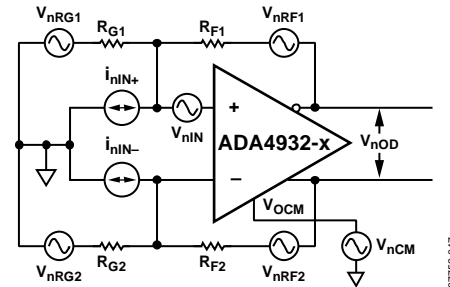


Figure 56. Noise Model

Table 11. Output Noise Voltage Density Calculations for Matched Feedback Networks

Input Noise Contribution	Input Noise Term	Input Noise Voltage Density	Output Multiplication Factor	Differential Output Noise Voltage Density Term
Differential Input	v <sub>nIN</sub>	v <sub>nIN</sub>	G <sub>N</sub>	v <sub>nO1</sub> = G <sub>N</sub> (v <sub>nIN</sub> )
Inverting Input	i <sub>nIN-</sub>	i <sub>nIN-</sub> × (R <sub>F2</sub> )	1	v <sub>nO2</sub> = (i <sub>nIN-</sub> )(R <sub>F2</sub> )
Noninverting Input	i <sub>nIN+</sub>	i <sub>nIN+</sub> × (R <sub>F1</sub> )	1	v <sub>nO3</sub> = (i <sub>nIN+</sub> )(R <sub>F1</sub> )
V <sub>OCM</sub> Input	v <sub>nCM</sub>	v <sub>nCM</sub>	0	v <sub>nO4</sub> = 0 V
Gain Resistor, R <sub>G1</sub>	v <sub>nRG1</sub>	(4kTR <sub>G1</sub> ) <sup>1/2</sup>	R <sub>F1</sub> /R <sub>G1</sub>	v <sub>nO5</sub> = (R <sub>F1</sub> /R <sub>G1</sub> )(4kTR <sub>G1</sub> ) <sup>1/2</sup>
Gain Resistor, R <sub>G2</sub>	v <sub>nRG2</sub>	(4kTR <sub>G2</sub> ) <sup>1/2</sup>	R <sub>F2</sub> /R <sub>G2</sub>	v <sub>nO6</sub> = (R <sub>F2</sub> /R <sub>G2</sub> )(4kTR <sub>G2</sub> ) <sup>1/2</sup>
Feedback Resistor, R <sub>F1</sub>	v <sub>nRF1</sub>	(4kTR <sub>F1</sub> ) <sup>1/2</sup>	1	v <sub>nO7</sub> = (4kTR <sub>F1</sub> ) <sup>1/2</sup>
Feedback Resistor, R <sub>F2</sub>	v <sub>nRF2</sub>	(4kTR <sub>F2</sub> ) <sup>1/2</sup>	1	v <sub>nO8</sub> = (4kTR <sub>F2</sub> ) <sup>1/2</sup>

Table 12. Differential Input, DC-Coupled

Nominal Gain (dB)	R <sub>F</sub> (Ω)	R <sub>G</sub> (Ω)	R <sub>IN, dm</sub> (Ω)	Differential Output Noise Density (nV/√Hz)
0	499	499	998	9.25
6	499	249	498	12.9
10	768	243	486	18.2

Table 13. Single-Ended Ground-Referenced Input, DC-Coupled, R<sub>s</sub> = 50 Ω

Nominal Gain (dB)	R <sub>F</sub> (Ω)	R <sub>G1</sub> (Ω)	R <sub>T</sub> (Ω) (Std 1%)	R <sub>IN, cm</sub> (Ω)	R <sub>G2</sub> (Ω) <sup>1</sup>	Differential Output Noise Density (nV/√Hz)
0	511	499	53.6	665	525	9.19
6	523	249	57.6	374	276	12.6
10	806	243	57.6	392	270	17.7

<sup>1</sup> R<sub>G2</sub> = R<sub>G1</sub> + (R<sub>S</sub>||R<sub>T</sub>).

Similar to the case of a conventional op amp, the output noise voltage densities can be estimated by multiplying the input-referred terms at +IN and -IN by the appropriate output factor, where:

$$G_N = \frac{2}{(\beta_1 + \beta_2)}$$
 is the circuit noise gain.

$$\beta_1 = \frac{R_{G1}}{R_{F1} + R_{G1}} \text{ and } \beta_2 = \frac{R_{G2}}{R_{F2} + R_{G2}}$$
 are the feedback factors.

When the feedback factors are matched,  $R_{F1}/R_{G1} = R_{F2}/R_{G2}$ ,  $\beta_1 = \beta_2 = \beta$ , and the noise gain becomes

$$G_N = \frac{1}{\beta} = 1 + \frac{R_F}{R_G}$$

Note that the output noise from  $V_{OCM}$  goes to zero in this case. The total differential output noise density,  $v_{nOD}$ , is the root-sum-square of the individual output noise terms.

$$v_{nOD} = \sqrt{\sum_{i=1}^8 v_{nOi}^2}$$

Table 12 and Table 13 list several common gain settings, associated resistor values, input impedance, and output noise density for both balanced and unbalanced input configurations.

### IMPACT OF MISMATCHES IN THE FEEDBACK NETWORKS

As previously mentioned, even if the external feedback networks ( $R_F/R_G$ ) are mismatched, the internal common-mode feedback loop still forces the outputs to remain balanced. The amplitudes of the signals at each output remain equal and 180° out of phase. The input-to-output differential mode gain varies proportionately to the feedback mismatch, but the output balance is unaffected.

The gain from the  $V_{OCM}$  pin to  $V_{OUT, dm}$  is equal to

$$\frac{2(\beta_1 - \beta_2)}{(\beta_1 + \beta_2)}$$

When  $\beta_1 = \beta_2$ , this term goes to zero and there is no differential output voltage due to the voltage on the  $V_{OCM}$  input (including noise). The extreme case occurs when one loop is open and the other has 100% feedback; in this case, the gain from  $V_{OCM}$  input to  $V_{OUT, dm}$  is either +2 or -2, depending on which loop is closed.

The feedback loops are nominally matched to within 1% in most applications, and the output noise and offsets due to the  $V_{OCM}$  input are negligible. If the loops are intentionally mismatched by a large amount, it is necessary to include the gain term from  $V_{OCM}$  to  $V_{OUT, dm}$  and account for the extra noise. For example, if  $\beta_1 = 0.5$  and  $\beta_2 = 0.25$ , the gain from  $V_{OCM}$  to  $V_{OUT, dm}$  is 0.67. If the  $V_{OCM}$  pin is set to 2.5 V, a differential offset voltage is present at the output of  $(2.5 \text{ V})(0.67) = 1.67 \text{ V}$ . The differential output noise contribution is  $(9.6 \text{ nV}/\sqrt{\text{Hz}})(0.67) = 6.4 \text{ nV}/\sqrt{\text{Hz}}$ . Both of these results are undesirable in most applications; therefore, it is best to use nominally matched feedback factors.

Mismatched feedback networks also result in a degradation of the ability of the circuit to reject input common-mode signals, much the same as for a four-resistor difference amplifier made from a conventional op amp.

As a practical summarization of the above issues, resistors of 1% tolerance produce a worst-case input CMRR of approximately 40 dB, a worst-case differential-mode output offset of 25 mV due to a 2.5 V  $V_{OCM}$  input, negligible  $V_{OCM}$  noise contribution, and no significant degradation in output balance error.

### CALCULATING THE INPUT IMPEDANCE FOR AN APPLICATION CIRCUIT

The effective input impedance of a circuit depends on whether the amplifier is being driven by a single-ended or differential signal source. For balanced differential input signals, as shown in Figure 57, the input impedance ( $R_{IN, dm}$ ) between the inputs (+DIN and -DIN) is  $R_{IN, dm} = R_G + R_G = 2 \times R_G$ .



Figure 57. ADA4932-x Configured for Balanced (Differential) Inputs

For an unbalanced, single-ended input signal (see Figure 58), the input impedance is

$$R_{IN, se} = \left( \frac{R_G}{1 - \frac{R_F}{2 \times (R_G + R_F)}} \right)$$

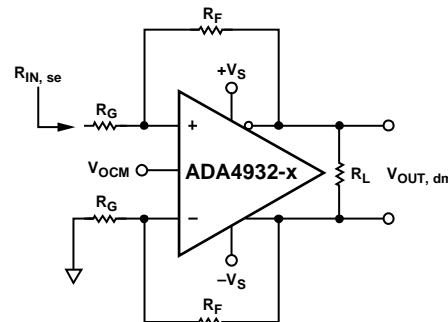


Figure 58. ADA4932-x with Unbalanced (Single-Ended) Input

The input impedance of the circuit is effectively higher than it is for a conventional op amp connected as an inverter because a fraction of the differential output voltage appears at the inputs as a common-mode signal, partially bootstrapping the voltage across the input resistor,  $R_G$ . The common-mode voltage at the amplifier input terminals can be easily determined by noting that the voltage at the inverting input is equal to the noninverting output voltage divided down by the voltage divider that is formed by  $R_F$  and  $R_G$  in the lower loop. This voltage is present at both

input terminals due to negative voltage feedback and is in phase with the input signal, thus reducing the effective voltage across  $R_G$  in the upper loop and partially bootstrapping  $R_G$ .

**Terminating a Single-Ended Input**

This section describes how to properly terminate a single-ended input to the ADA4932-x with a gain of 1,  $R_F = 499 \Omega$ , and  $R_G = 499 \Omega$ . An example using an input source with a terminated output voltage of 1 V p-p and source resistance of 50  $\Omega$  illustrates the four steps that must be followed. Note that because the terminated output voltage of the source is 1 V p-p, the open-circuit output voltage of the source is 2 V p-p. The source shown in Figure 59 indicates this open-circuit voltage.

1. The input impedance is calculated using the formula

$$R_{IN,se} = \left( \frac{R_G}{1 - \frac{R_G}{R_F}} \right) = \left( \frac{499}{1 - \frac{499}{499}} \right) = 665 \Omega$$



Figure 59. Calculating Single-Ended Input Impedance,  $R_{IN}$

2. To match the 50  $\Omega$  source resistance, calculate the termination resistor,  $R_T$ , using  $R_T || 665 \Omega = 50 \Omega$ . The closest standard 1% value for  $R_T$  is 53.6  $\Omega$ .



Figure 60. Adding Termination Resistor,  $R_T$

3. Figure 60 shows that the effective  $R_G$  in the upper feedback loop is now greater than the  $R_G$  in the lower loop due to the addition of the termination resistors. To compensate for the imbalance of the gain resistors, add a correction resistor ( $R_{TS}$ ) in series with  $R_G$  in the lower loop.  $R_{TS}$  is the Thevenin equivalent of the source resistance,  $R_S$ , and the termination resistance,  $R_T$ , and is equal to  $R_S || R_T$ .

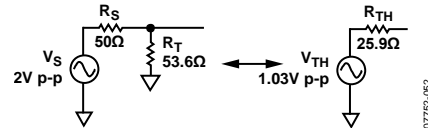


Figure 61. Calculating the Thevenin Equivalent

$R_{TS} = R_{TH} = R_S || R_T = 25.9 \Omega$ . Note that  $V_{TH}$  is greater than 1 V p-p, which was obtained with  $R_T = 50 \Omega$ . The modified circuit with the Thevenin equivalent (closest 1% value used for  $R_{TH}$ ) of the terminated source and  $R_{TS}$  in the lower feedback loop is shown in Figure 62.

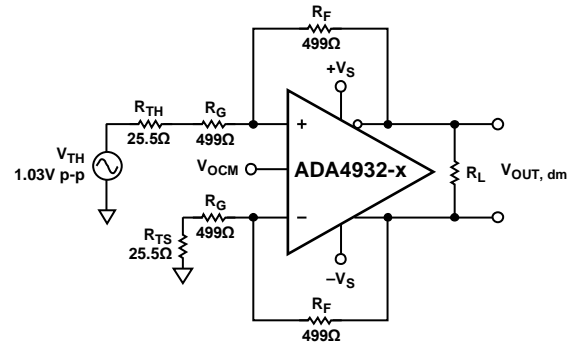


Figure 62. Thevenin Equivalent and Matched Gain Resistors

Figure 62 presents a tractable circuit with matched feedback loops that can be easily evaluated.

It is useful to point out two effects that occur with a terminated input. The first is that the value of  $R_G$  is increased in both loops, lowering the overall closed-loop gain. The second is that  $V_{TH}$  is a little larger than 1 V p-p, as it would be if  $R_T = 50 \Omega$ . These two effects have opposite impacts on the output voltage, and for large resistor values in the feedback loops (~1 k $\Omega$ ), the effects essentially cancel each other out. For small  $R_F$  and  $R_G$ , or high gains, however, the diminished closed-loop gain is not canceled completely by the increased  $V_{TH}$ . This can be seen by evaluating Figure 62.

The desired differential output in this example is 1 V p-p because the terminated input signal was 1 V p-p and the closed-loop gain = 1. The actual differential output voltage, however, is equal to  $(1.03 \text{ V p-p})(499/524.5) = 0.98 \text{ V p-p}$ . To obtain the desired output voltage of 1 V p-p, a final gain adjustment can be made by increasing  $R_F$  without modifying any of the input circuitry. This is discussed in Step 4.

4. The feedback resistor value is modified as a final gain adjustment to obtain the desired output voltage.

To make the output voltage  $V_{OUT} = 1\text{ V p-p}$ , calculate  $R_F$  using the following formula:

$$R_F = \frac{(\text{Desired } V_{OUT, dm})(R_G + R_{TS})}{V_{TH}} = \frac{(1\text{ V p-p})(524.5\ \Omega)}{1.03\text{ V p-p}} = 509\ \Omega$$

The closest standard 1% value to  $509\ \Omega$  is  $511\ \Omega$ , which gives a differential output voltage of  $1.00\text{ V p-p}$ .

The final circuit is shown in Figure 63.

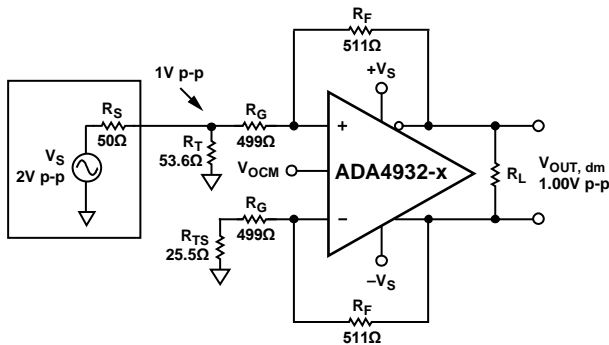


Figure 63. Terminated Single-Ended-to-Differential System with  $G = 2$

### INPUT COMMON-MODE VOLTAGE RANGE

The ADA4932-x input common-mode range is shifted down by approximately one  $V_{BE}$ , in contrast to other ADC drivers with centered input ranges such as the ADA4939-x. The downward-shifted input common-mode range is especially suited to dc-coupled, single-ended-to-differential, and single-supply applications.

For  $\pm 5\text{ V}$  operation, the input common-mode range at the summing nodes of the amplifier is specified as  $-4.8\text{ V}$  to  $+3.2\text{ V}$ , and is specified as  $+0.2\text{ V}$  to  $+3.2\text{ V}$  with a  $+5\text{ V}$  supply. To avoid nonlinearities, the voltage swing at the  $+IN$  and  $-IN$  terminals must be confined to these ranges.

### INPUT AND OUTPUT CAPACITIVE AC COUPLING

While the ADA4932-x is best suited to dc-coupled applications, it is nonetheless possible to use it in ac-coupled circuits. Input ac coupling capacitors can be inserted between the source and  $R_G$ . This ac coupling blocks the flow of the dc common-mode feedback current and causes the ADA4932-x dc input common-mode voltage to equal the dc output common-mode voltage. These ac coupling capacitors must be placed in both loops to keep the feedback factors matched. Output ac coupling capacitors can be placed in series between each output and its respective load.

### SETTING THE OUTPUT COMMON-MODE VOLTAGE

The  $V_{OCM}$  pin of the ADA4932-x is internally biased with a voltage divider comprised of two  $50\text{ k}\Omega$  resistors across the supplies, with a tap at a voltage approximately equal to the midsupply point,  $[(+V_S) + (-V_S)]/2$ . Because of this internal divider, the  $V_{OCM}$  pin sources and sinks current, depending on the externally applied voltage and its associated source resistance. Relying on the internal bias results in an output common-mode voltage that is within about  $100\text{ mV}$  of the expected value.

In cases where more accurate control of the output common-mode level is required, it is recommended that an external source or resistor divider be used with source resistance less than  $100\ \Omega$ . If an external voltage divider consisting of equal resistor values is used to set  $V_{OCM}$  to midsupply with greater accuracy than produced internally, higher values can be used because the external resistors are placed in parallel with the internal resistors. The output common-mode offset listed in the Specifications section assumes that the  $V_{OCM}$  input is driven by a low impedance voltage source.

It is also possible to connect the  $V_{OCM}$  input to a common-mode level (CML) output of an ADC; however, care must be taken to ensure that the output has sufficient drive capability. The input impedance of the  $V_{OCM}$  pin is approximately  $10\text{ k}\Omega$ . If multiple ADA4932-x devices share one ADC reference output, a buffer may be necessary to drive the parallel inputs.

## LAYOUT, GROUNDING, AND BYPASSING

As a high speed device, the ADA4932-x is sensitive to the PCB environment in which it operates. Realizing its superior performance requires attention to the details of high speed PCB design.

The first requirement is a solid ground plane that covers as much of the board area around the ADA4932-x as possible. However, the area near the feedback resistors ( $R_F$ ), gain resistors ( $R_G$ ), and the input summing nodes (Pin 2 and Pin 3) should be cleared of all ground and power planes (see Figure 64). Clearing the ground and power planes minimizes any stray capacitance at these nodes and thus minimizes peaking of the response of the amplifier at high frequencies.

The thermal resistance,  $\theta_{JA}$ , is specified for the device, including the exposed pad, soldered to a high thermal conductivity 4-layer circuit board, as described in EIA/JESD51-7.



Figure 64. Ground and Power Plane Voiding in Vicinity of  $R_F$  and  $R_G$

Bypass the power supply pins as close to the device as possible and directly to a nearby ground plane. High frequency ceramic chip capacitors should be used. It is recommended that two parallel bypass capacitors (1000 pF and 0.1  $\mu$ F) be used for each supply. Place the 1000 pF capacitor closer to the device. Further away, provide low frequency bulk bypassing using 10  $\mu$ F tantalum capacitors from each supply to ground.

Signal routing should be short and direct to avoid parasitic effects. Wherever complementary signals exist, provide a symmetrical layout to maximize balanced performance. When routing differential signals over a long distance, keep PCB traces close together, and twist any differential wiring to minimize loop area. Doing this reduces radiated energy and makes the circuit less susceptible to interference.

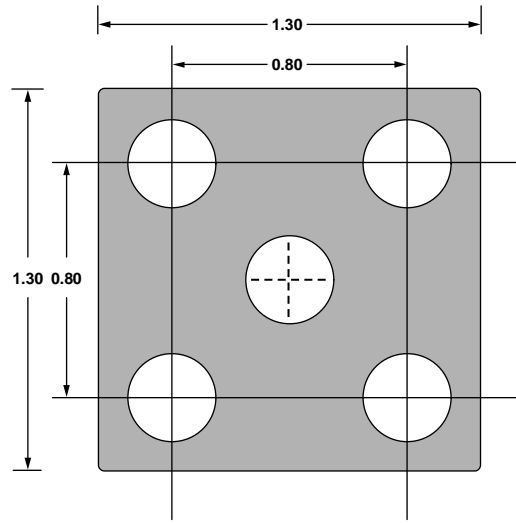


Figure 65. Recommended PCB Thermal Attach Pad Dimensions (Millimeters)



Figure 66. Cross-Section of 4-Layer PCB Showing Thermal Via Connection to Buried Ground Plane (Dimensions in Millimeters)



## HIGH PERFORMANCE ADC DRIVING

The ADA4932-x is ideally suited for broadband dc-coupled applications. The circuit in Figure 67 shows a front-end connection for an ADA4932-1 driving an AD9245, a 14-bit, 20 MSPS/40 MSPS/65 MSPS/80 MSPS ADC, with dc coupling on the ADA4932-1 input and output. (The AD9245 achieves its optimum performance when driven differentially.) The ADA4932-1 eliminates the need for a transformer to drive the ADC and performs a single-ended-to-differential conversion and buffering of the driving signal.

The ADA4932-1 is configured with a single 3.3 V supply and a gain of 1 for a single-ended input to differential output. The 53.6 Ω termination resistor, in parallel with the single-ended input impedance of approximately 665 Ω, provides a 50 Ω termination for the source. The additional 25.5 Ω (524.5 Ω total) at the inverting input balances the parallel impedance of the 50 Ω source and the termination resistor driving the noninverting input.

In this example, the signal generator has a 1 V p-p symmetric, ground-referenced bipolar output when terminated in 50 Ω. The V<sub>OCM</sub> input is bypassed for noise reduction, and set externally with 1% resistors to maximize output dynamic range on the tight 3.3 V supply.

Because the inputs are dc-coupled, dc common-mode current flows in the feedback loops, and a nominal dc level of 0.84 V is present at the amplifier input terminals. A fraction of the output signal is also present at the input terminals as a common-mode signal; its level is equal to the ac output swing at the noninverting output, divided down by the feedback factor of the lower loop. In this example, this ripple is  $0.5 \text{ V p-p} \times [524.5 / (524.5 + 511)] = 0.25 \text{ V p-p}$ . This ac signal is riding on the 0.84 V dc level, producing a voltage swing between 0.72 V and 0.97 V at the input terminals. This is well within the specified limits of 0.2 V to 1.5 V.

With an output common-mode voltage of 1.65 V, each ADA4932-1 output swings between 1.4 V and 1.9 V, opposite in phase, providing a gain of 1 and a 1 V p-p differential signal to the ADC input. The differential RC section between the ADA4932-1 output and the ADC provides single-pole low-pass filtering and extra buffering for the current spikes that are output from the ADC input when its SHA capacitors are discharged.

The AD9245 is configured for a 1 V p-p full-scale input by connecting its SENSE pin to VREF, as shown in Figure 67.

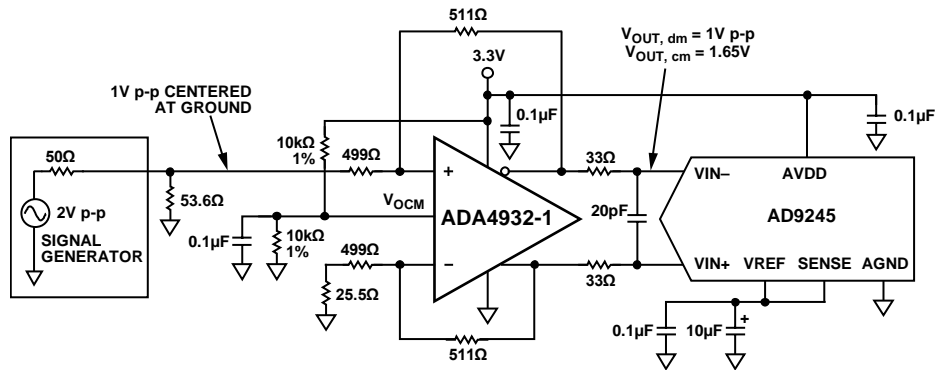
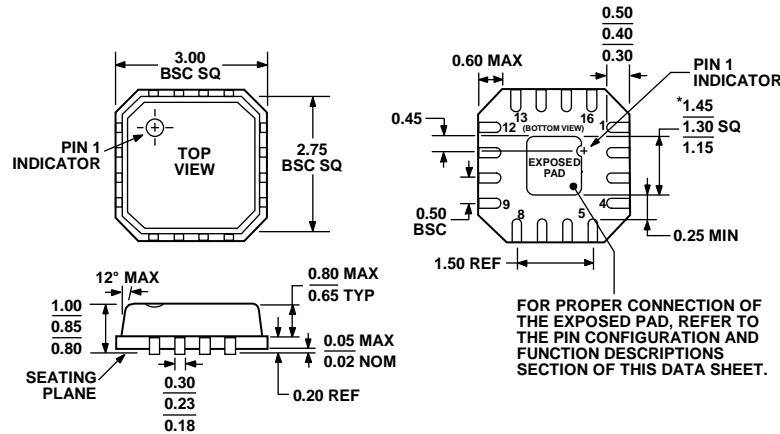


Figure 67. ADA4932-1 Driving an AD9245 ADC with DC-Coupled Input and Output

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OUTLINE DIMENSIONS



\*COMPLIANT TO JEDEC STANDARDS MO-220-VEED-2 EXCEPT FOR EXPOSED PAD DIMENSION.

Figure 68. 16-Lead Lead Frame Chip Scale Package [LFCSP\_VQ]  
3 mm x 3 mm Body, Very Thin Quad (CP-16-2)  
Dimensions shown in millimeters

072209-A



COMPLIANT TO JEDEC STANDARDS MO-220-WGGD-8.

Figure 69. 24-Lead Lead Frame Chip Scale Package [LFCSP\_WQ]  
4 mm x 4 mm Body, Very Very Thin Quad (CP-24-14)  
Dimensions shown in millimeters

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ORDERING GUIDE

Model <sup>1</sup>	Temperature Range	Package Description	Package Option	Ordering Quantity	Branding
ADA4932-1YCPZ-R2	-40°C to +105°C	16-Lead LFCSP_VQ	CP-16-2	250	H1K
ADA4932-1YCPZ-RL	-40°C to +105°C	16-Lead LFCSP_VQ	CP-16-2	5,000	H1K
ADA4932-1YCPZ-R7	-40°C to +105°C	16-Lead LFCSP_VQ	CP-16-2	1,500	H1K
ADA4932-1YCP-EBZ		Evaluation Board			
ADA4932-2YCPZ-R2	-40°C to +105°C	24-Lead LFCSP_WQ	CP-24-14	250	
ADA4932-2YCPZ-RL	-40°C to +105°C	24-Lead LFCSP_WQ	CP-24-14	5,000	
ADA4932-2YCPZ-R7	-40°C to +105°C	24-Lead LFCSP_WQ	CP-24-14	1,500	
ADA4932-2YCP-EBZ		Evaluation Board			

<sup>1</sup> Z = RoHS Compliant Part.

**NOTES**

NOTES

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- Комплексную поставку.
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- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



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